

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

| SUBMISSION TYPE: | NEW ASSIGNMENT | | | | | | | | | | |
|--|--|----------------|---------------------|------------|---------|------------|--------------|------------|------------|------------|--|
| NATURE OF CONVEYANCE: | ASSIGNMENT | | | | | | | | | | |
| CONVEYING PARTY DATA | | | | | | | | | | | |
| <table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Fengyi Jiang</td><td>08/14/2007</td></tr><tr><td>Li Wang</td><td>08/14/2007</td></tr><tr><td>Wenqing Fang</td><td>08/16/2007</td></tr><tr><td>Chunlan Mo</td><td>08/16/2007</td></tr></tbody></table> | Name | Execution Date | Fengyi Jiang | 08/14/2007 | Li Wang | 08/14/2007 | Wenqing Fang | 08/16/2007 | Chunlan Mo | 08/16/2007 | |
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| Fengyi Jiang | 08/14/2007 | | | | | | | | | | |
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| Wenqing Fang | 08/16/2007 | | | | | | | | | | |
| Chunlan Mo | 08/16/2007 | | | | | | | | | | |
| RECEIVING PARTY DATA | | | | | | | | | | | |
| Name: | Lattice Power (JIANGXI) Corporation | | | | | | | | | | |
| Street Address: | Institute of Material Science, North Area of Nanchang University | | | | | | | | | | |
| Internal Address: | No. 235 East Nanjing Road | | | | | | | | | | |
| City: | Nanchang, Jiangxi Province 330047 | | | | | | | | | | |
| State/Country: | CHINA | | | | | | | | | | |
| PROPERTY NUMBERS Total: 1 | | | | | | | | | | | |
| <table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11841116</td></tr></tbody></table> | Property Type | Number | Application Number: | 11841116 | | | | | | | |
| Property Type | Number | | | | | | | | | | |
| Application Number: | 11841116 | | | | | | | | | | |
| CORRESPONDENCE DATA | | | | | | | | | | | |
| Fax Number: | (530)759-1665 | | | | | | | | | | |
| <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> | | | | | | | | | | | |
| Phone: | 530-759-1667 | | | | | | | | | | |
| Email: | poornima@parklegal.com | | | | | | | | | | |
| Correspondent Name: | Shun Yao | | | | | | | | | | |
| Address Line 1: | Park, Vaughan & Fleming, LLP | | | | | | | | | | |
| Address Line 2: | 2820 Fifth Street | | | | | | | | | | |
| Address Line 4: | Davis, CALIFORNIA 95618 | | | | | | | | | | |
| ATTORNEY DOCKET NUMBER: | LTP07-1003-US | | | | | | | | | | |
| NAME OF SUBMITTER: | Shun Yao, Reg. No. 59,242 | | | | | | | | | | |
| Total Attachments: 2 | | | | | | | | | | | |

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CORPORATE ASSIGNMENT

WHEREAS, the undersigned,

Fengyi Jiang, Institute of Material Science, North Area of Nanchang University, No. 235 East Nanjing Road, Nanchang, Jiangxi Province 330047, People's Republic of China

Li Wang Institute of Material Science, North Area of Nanchang University, No. 235 East Nanjing Road, Nanchang, Jiangxi Province 330047, People's Republic of China

Wenqing Fang Institute of Material Science, North Area of Nanchang University, No. 235 East Nanjing Road, Nanchang, Jiangxi Province 330047, People's Republic of China

Chunlan Mo Institute of Material Science, North Area of Nanchang University, No. 235 East Nanjing Road, Nanchang, Jiangxi Province 330047, People's Republic of China

hereinafter termed "Inventor(s)", have invented certain new and useful improvements in

METHOD FOR FABRICATING A P-TYPE SEMICONDUCTOR STRUCTURE

and have executed a declaration or oath for an application for a United States patent disclosing and identifying the invention:

____ On the ____ day of _____, 20 ____;

Or

 X Said application having Application Number 11/841,116 and filed on 20 August 2007 ; and

WHEREAS, Lattice Power (JIANGXI) Corporation, a corporation of China, having a place of business at Institute of Material Science, North Area of Nanchang University, No. 235 East Nanjing Road, Nanchang, Jiangxi Province 330047, People's Republic of China, (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventor(s) (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor(s) to have been received in full from said Assignee:

1. Said Inventor(s) do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

2. Said Inventor(s) hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor(s) shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor(s) in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor(s), their respective heirs, legal representatives and assigns.

4. Said Inventor(s) hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventor(s) have executed and delivered this instrument to said Assignee as of the dates written below.

Fengyi Jiang

Date

Fengyi Jiang

2007-08-14

Li Wang

Date

Wangli

2007-8-14

Wenqing Fang

Date

Wenqing Fang

2007-8-16

Chunlan Mo

Date

Chunlan Mo

2007-8-16

Date